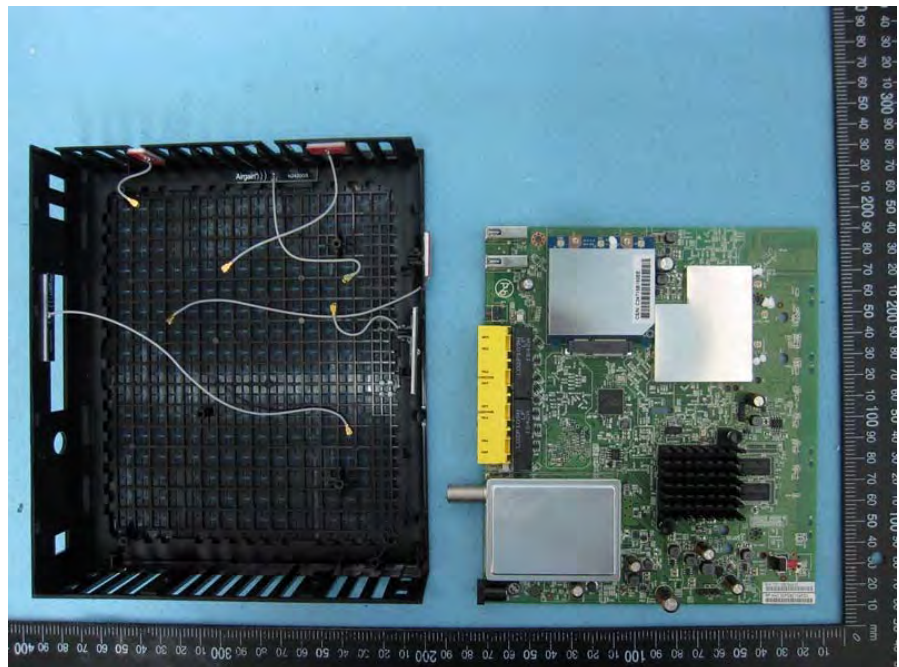
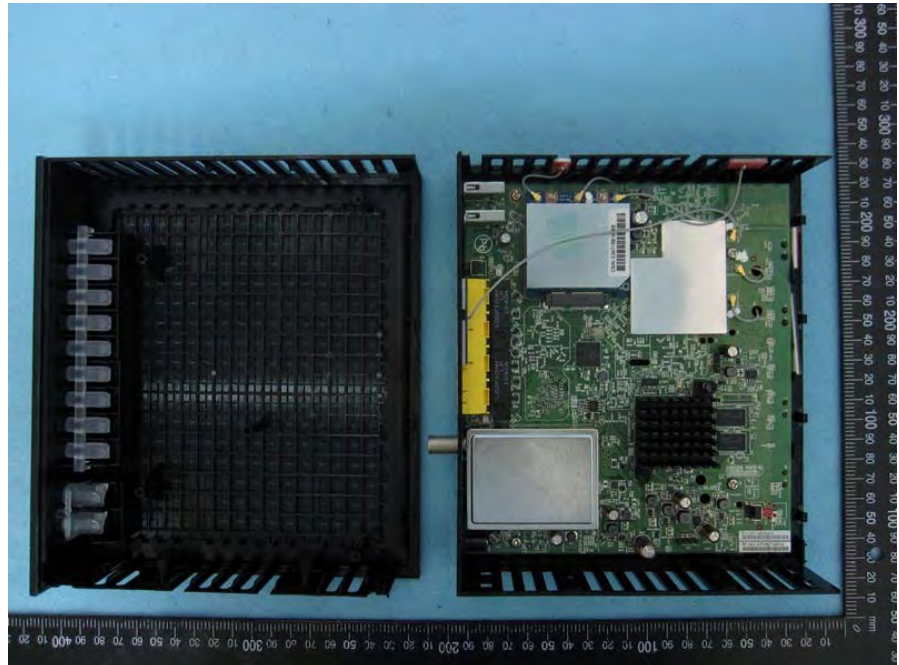
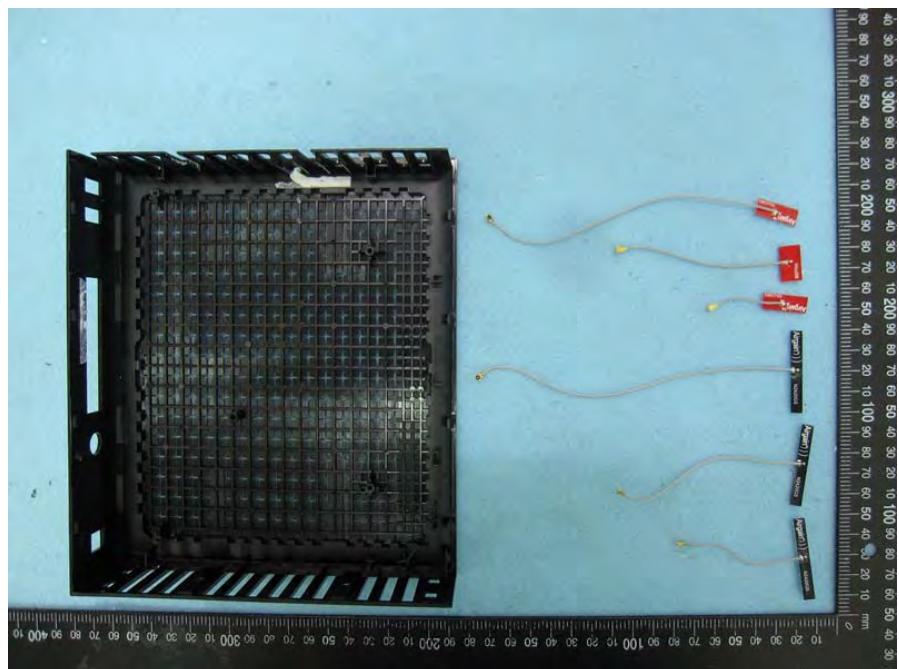
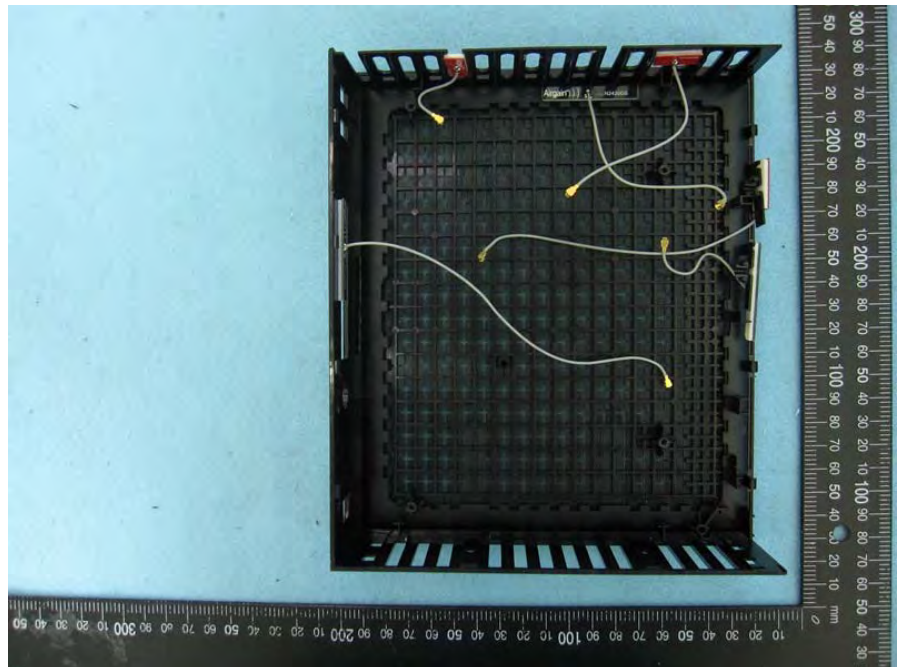
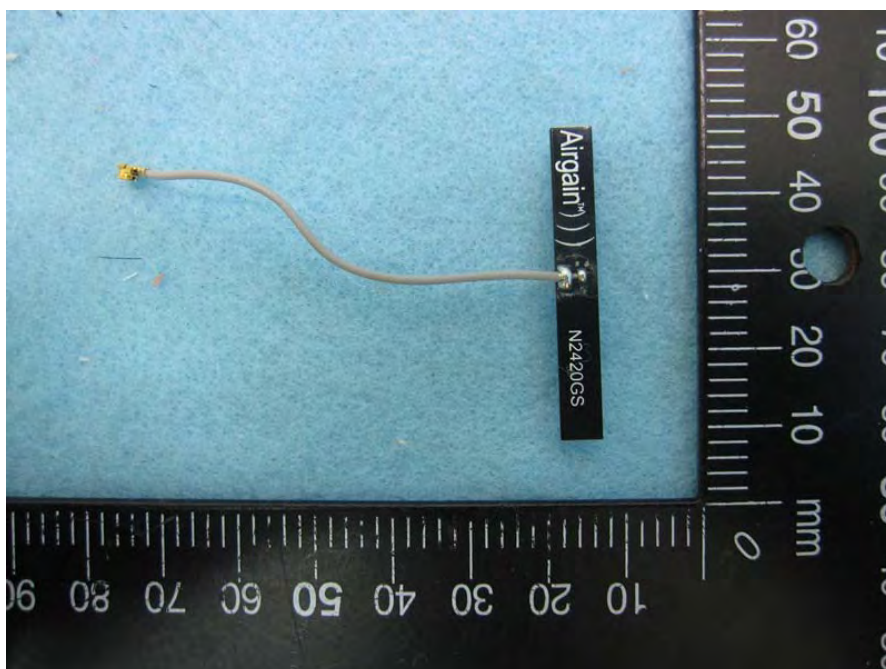
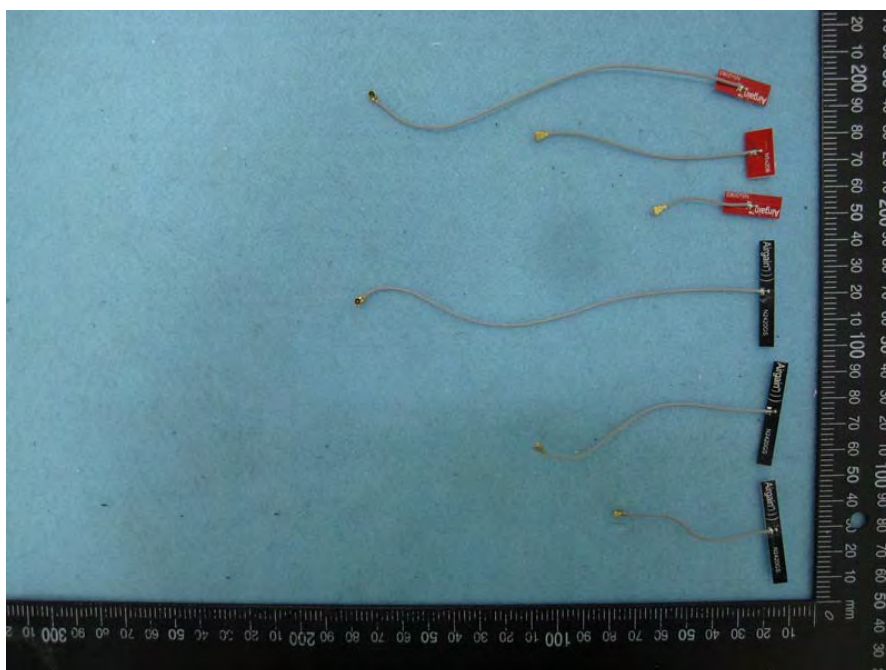
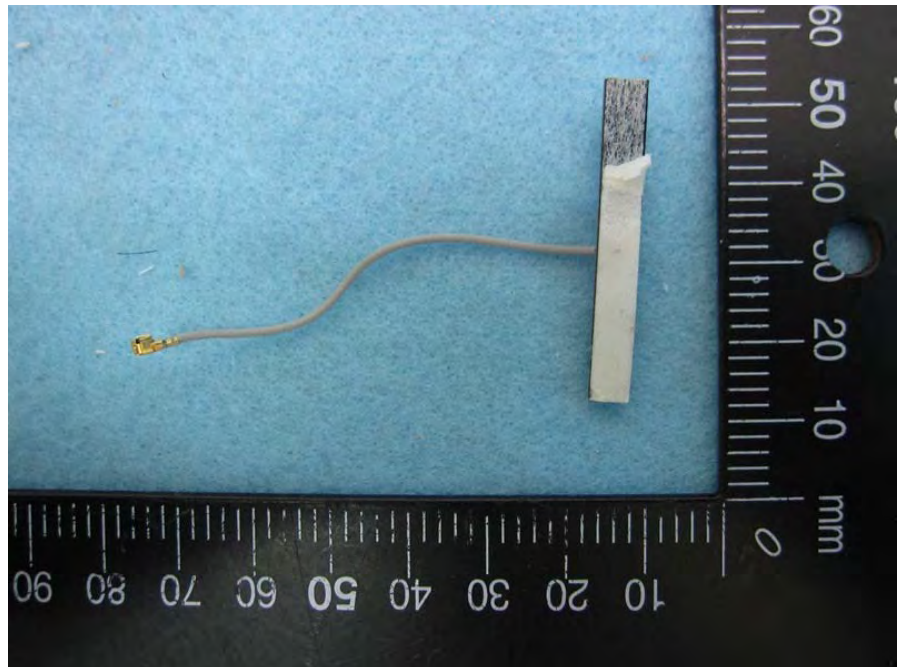
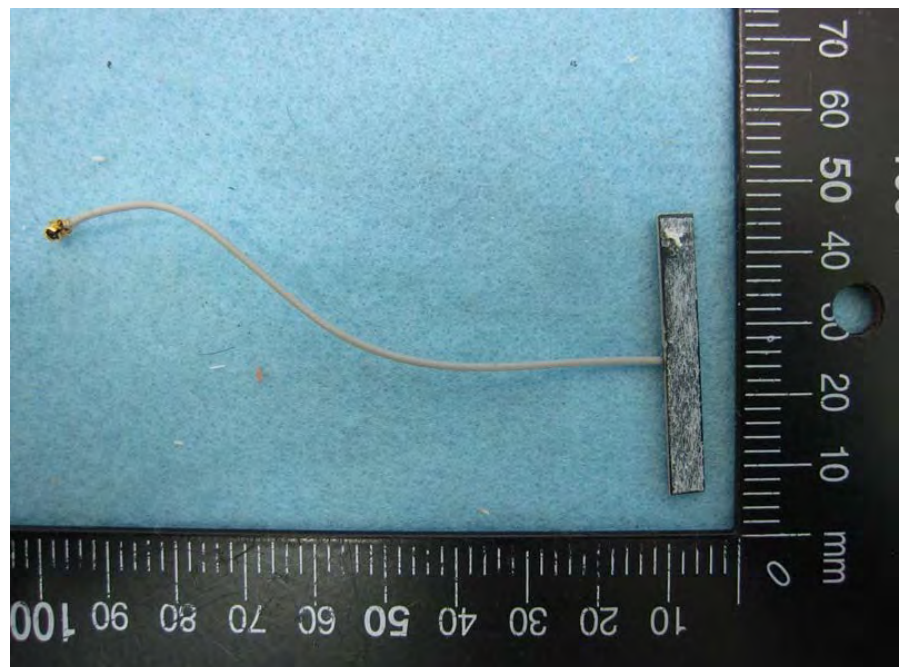
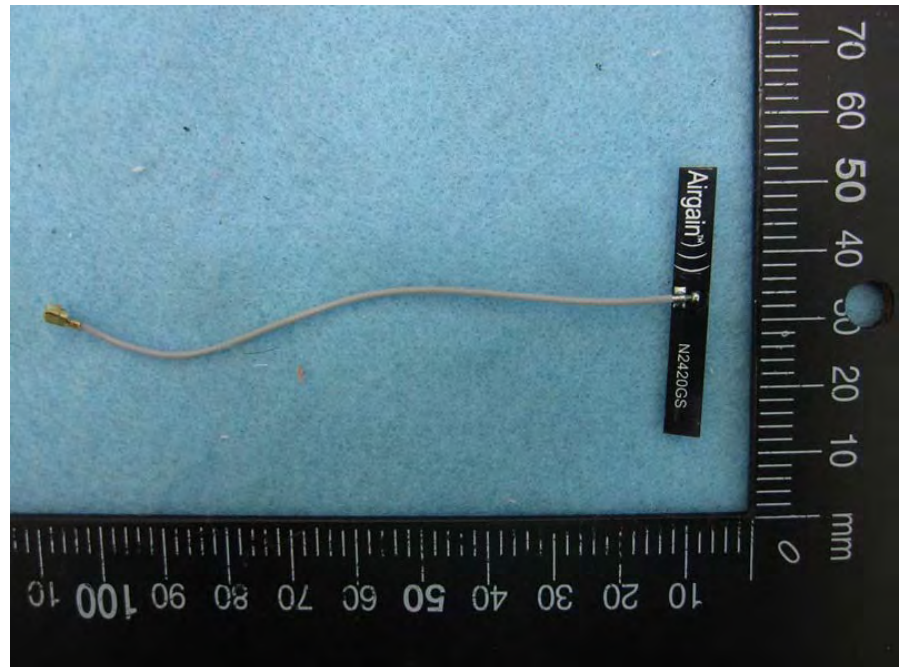


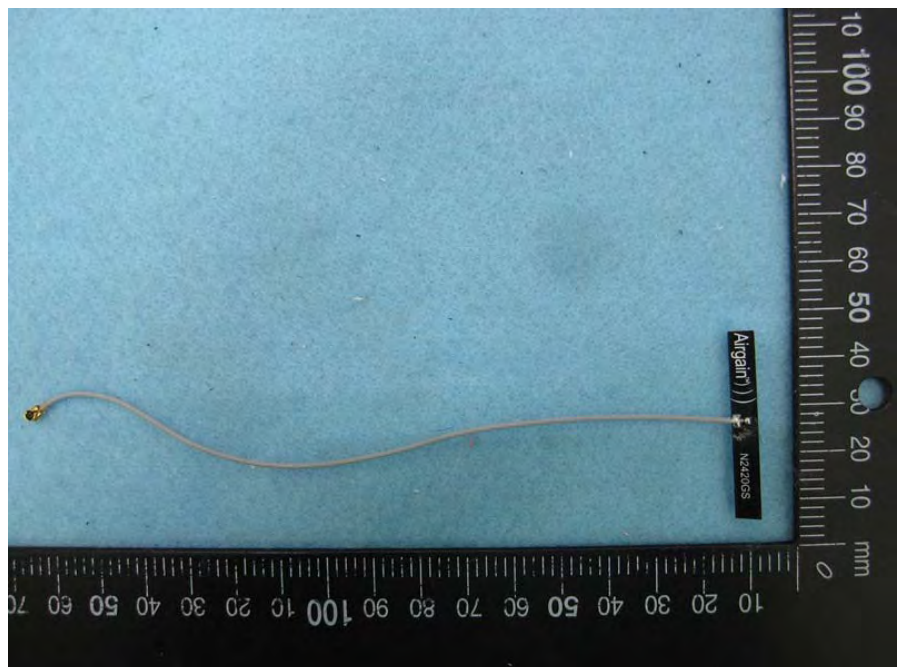


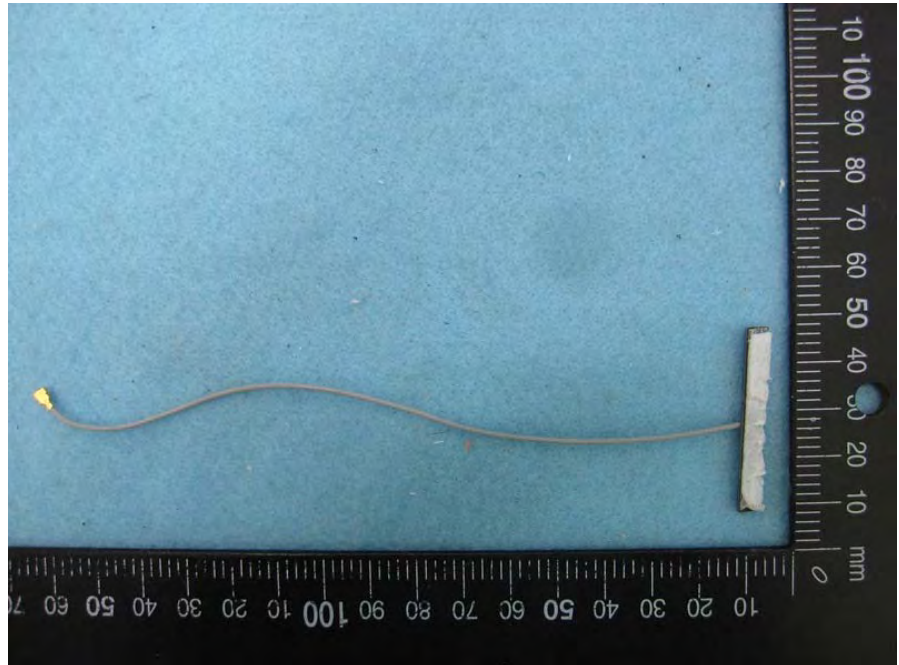


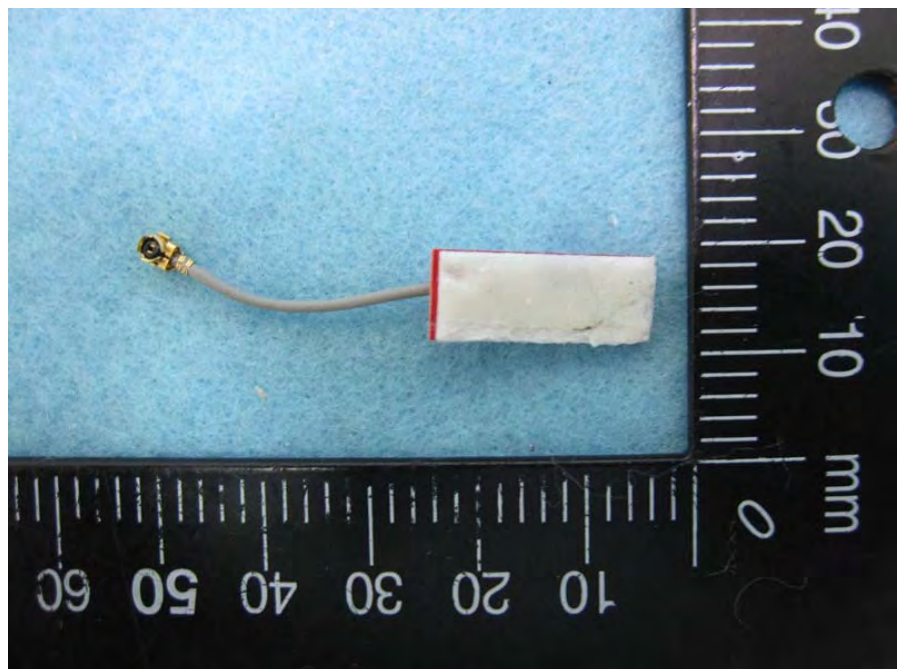
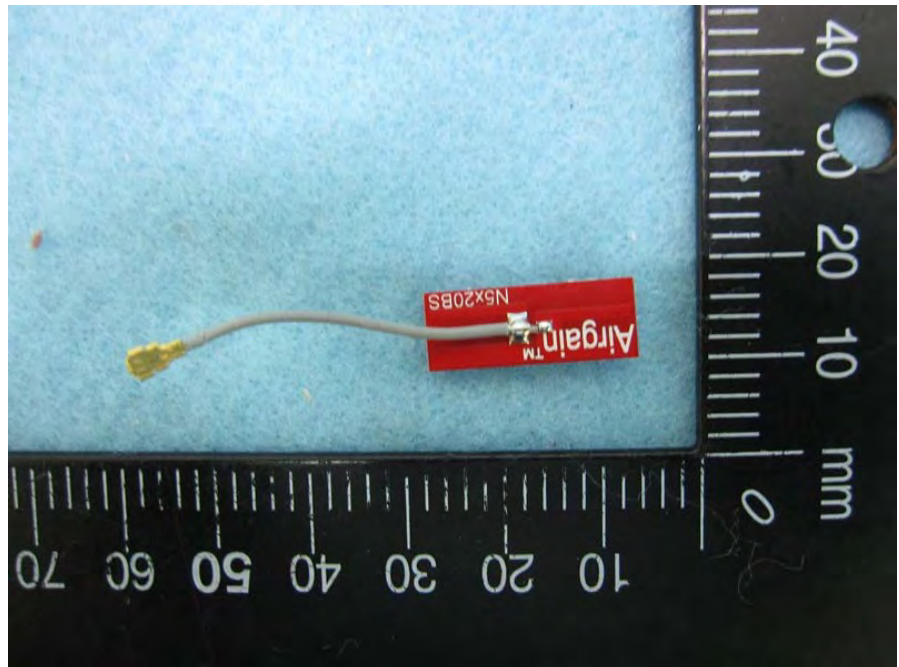


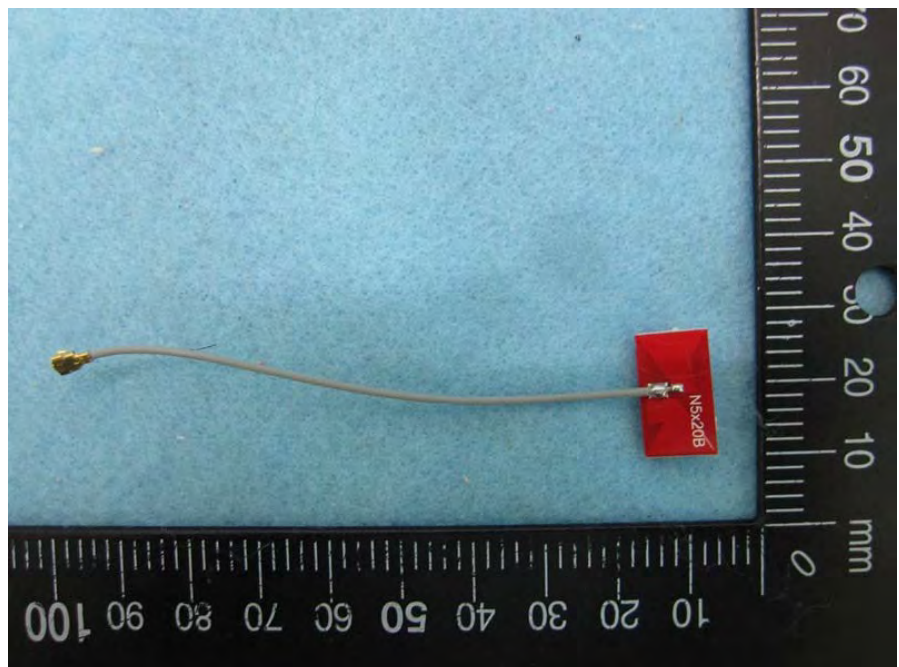


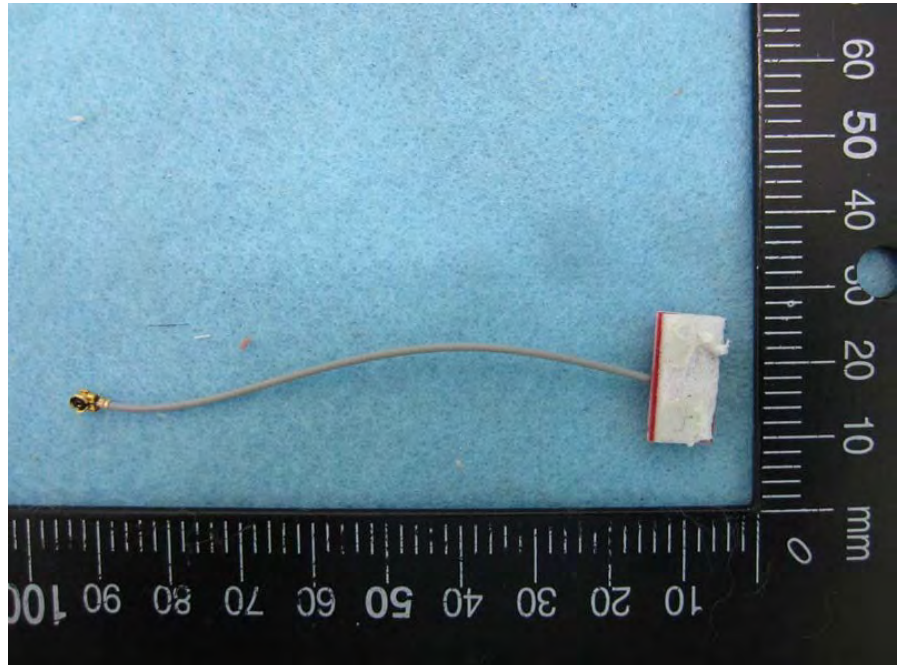


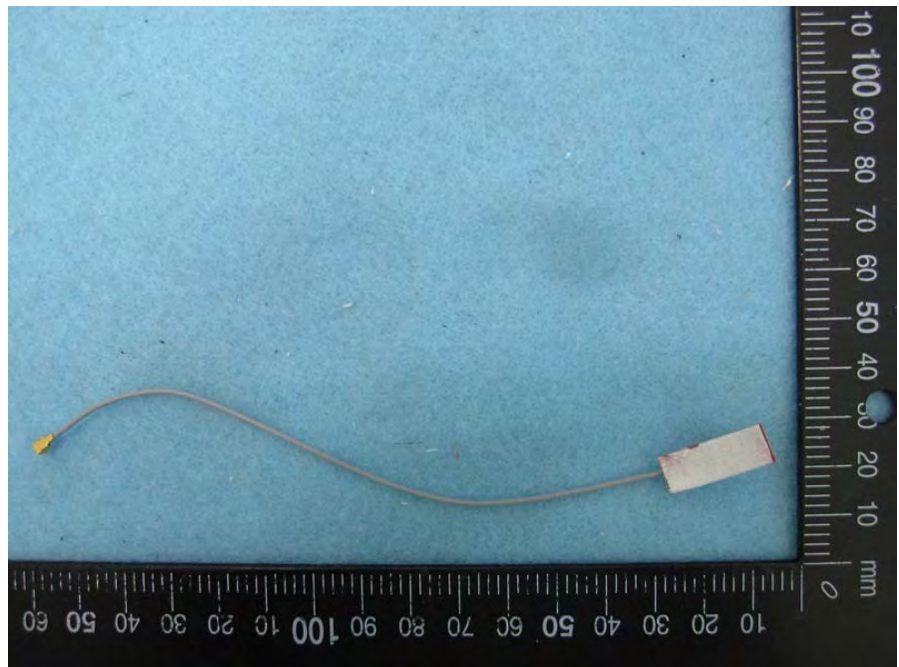
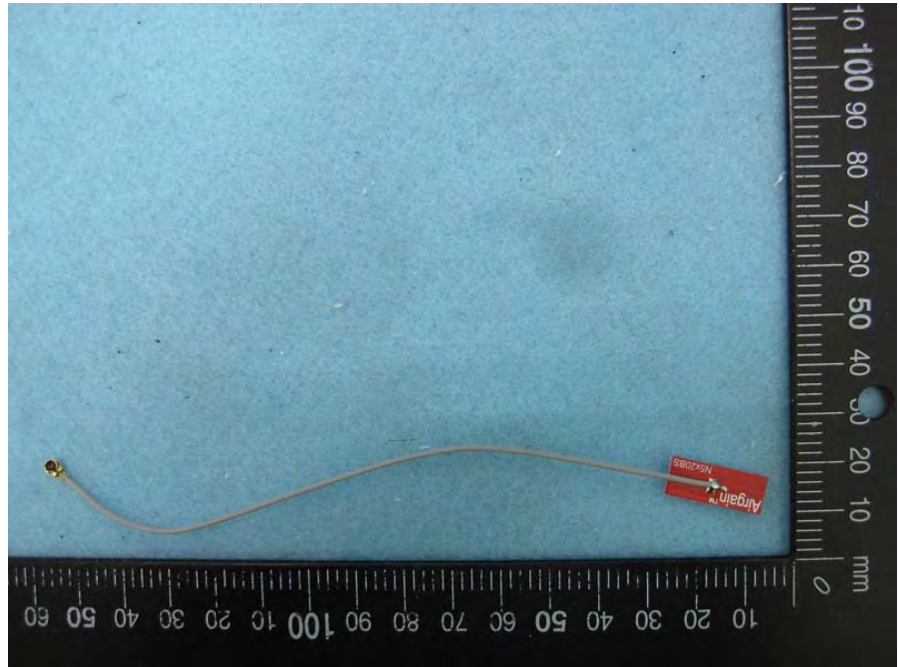








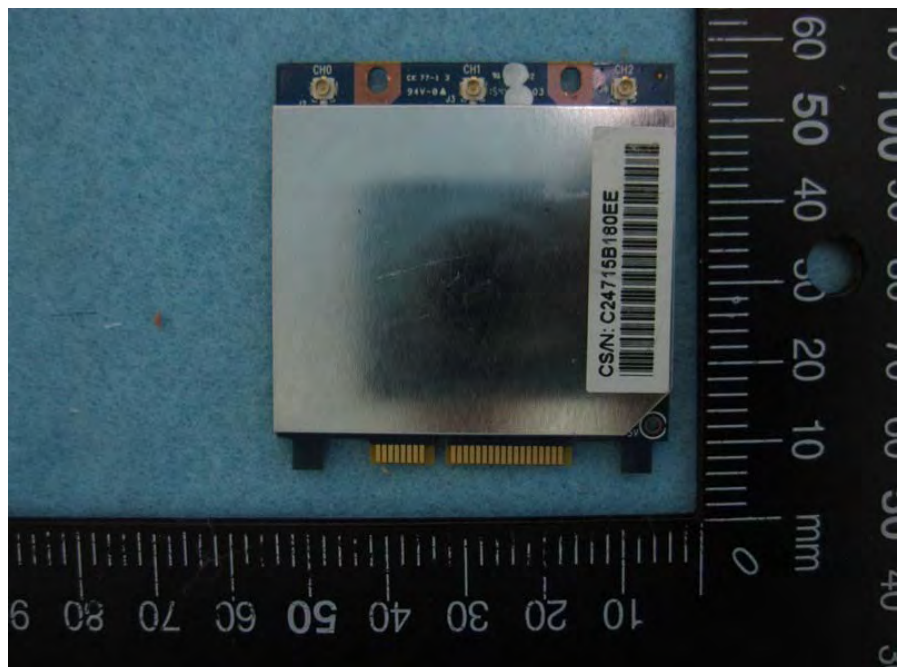


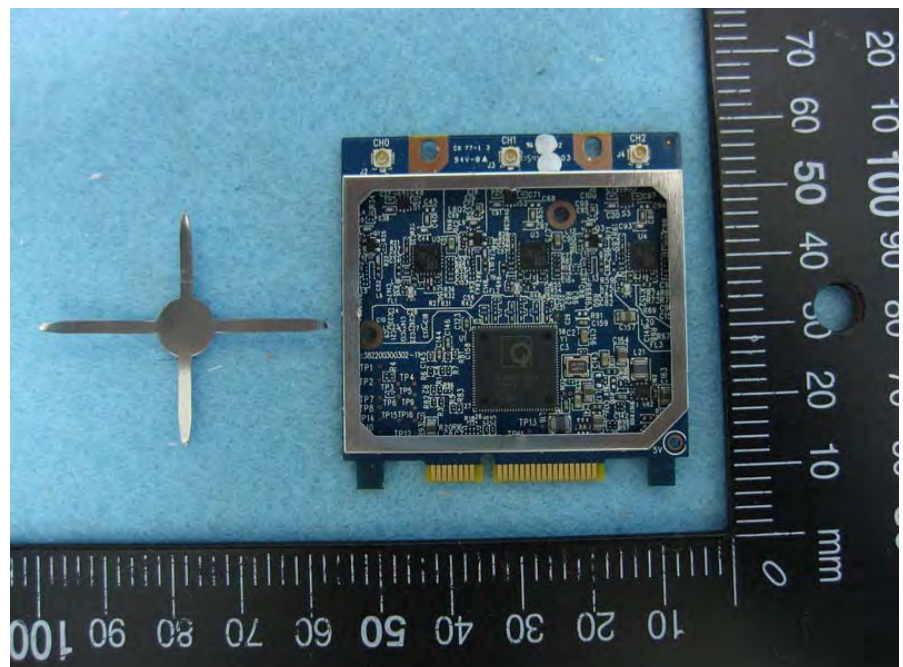
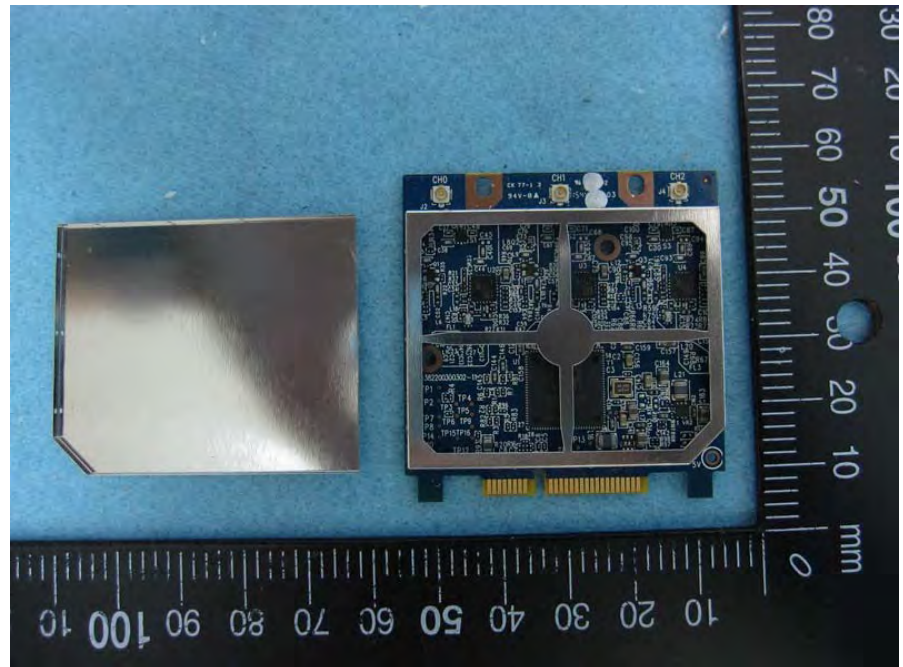


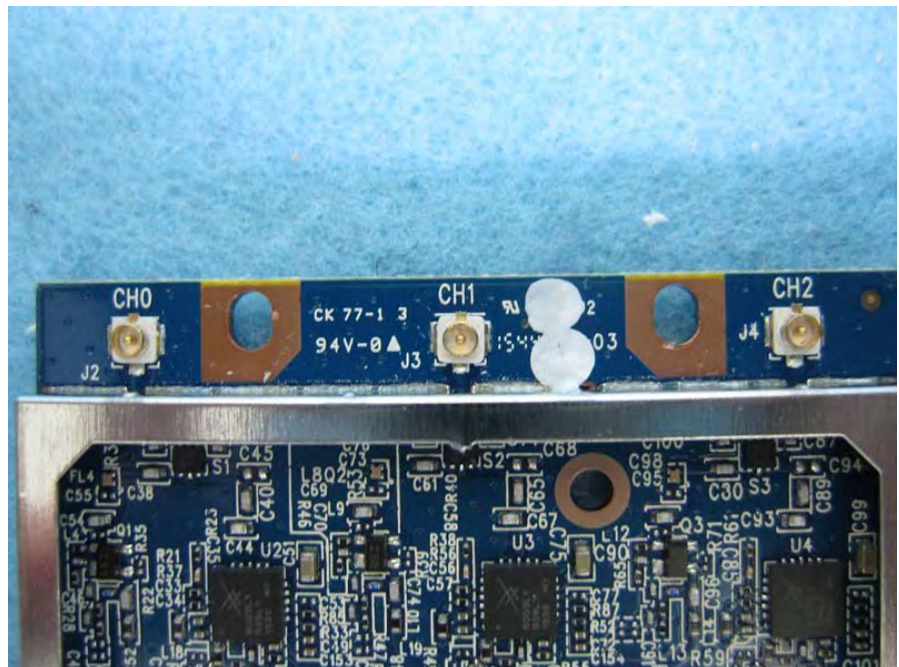
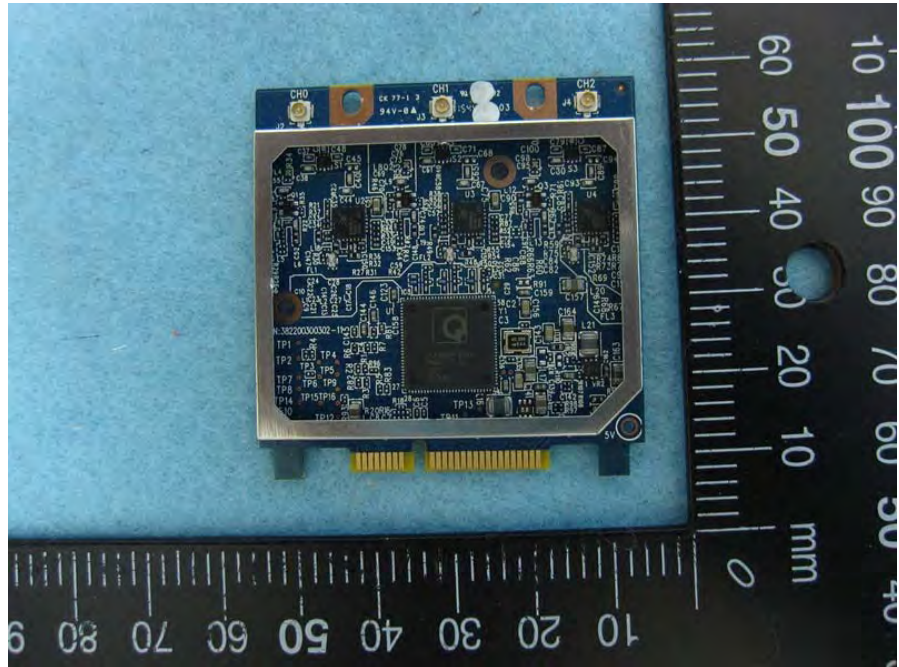




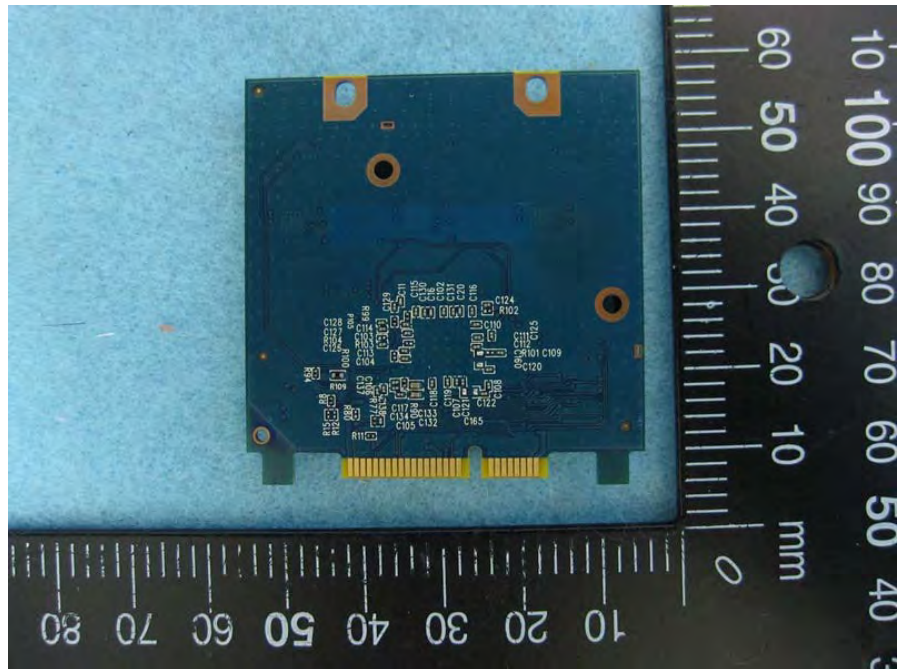
Main source of Power
Amplifier







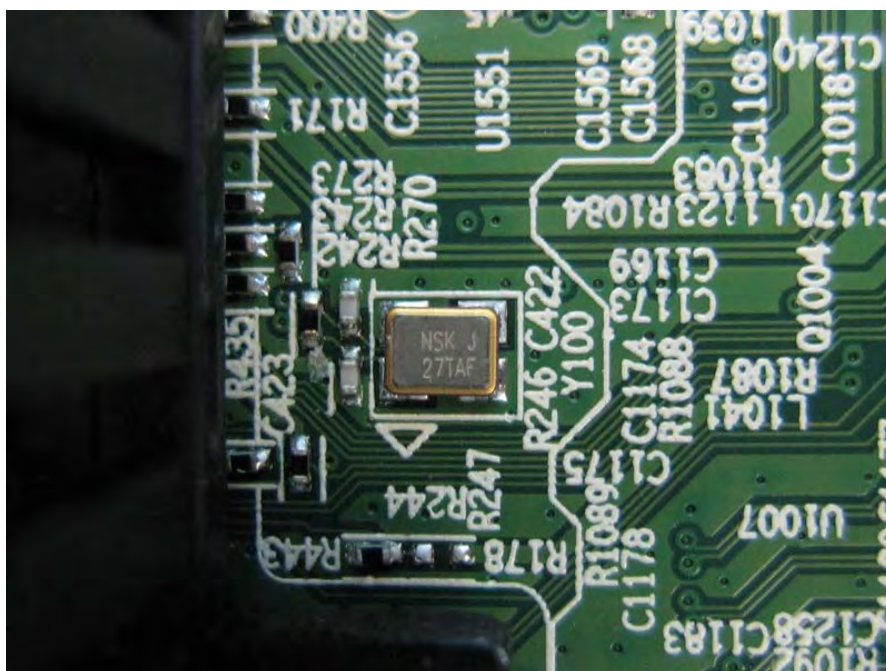


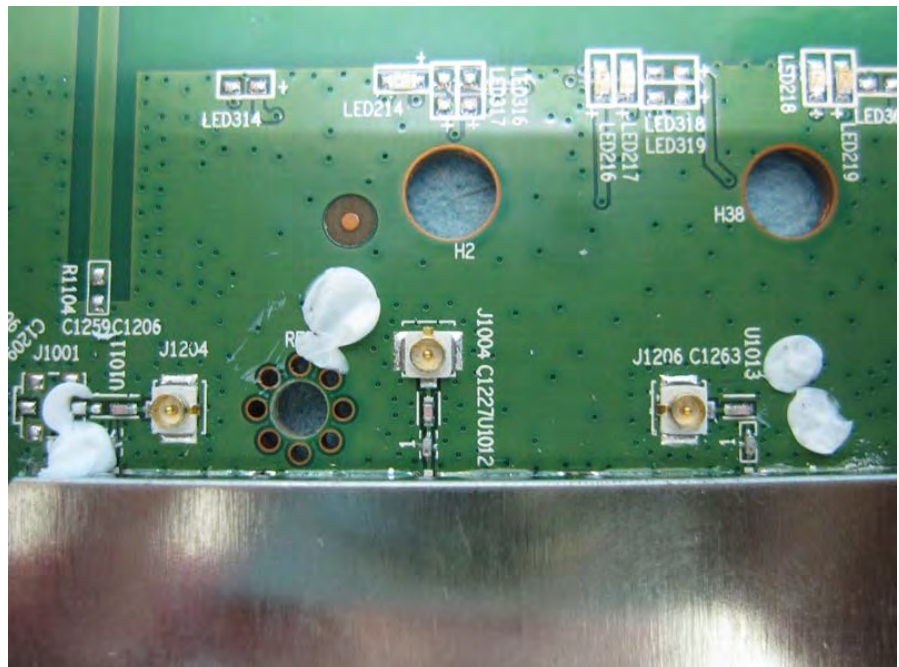


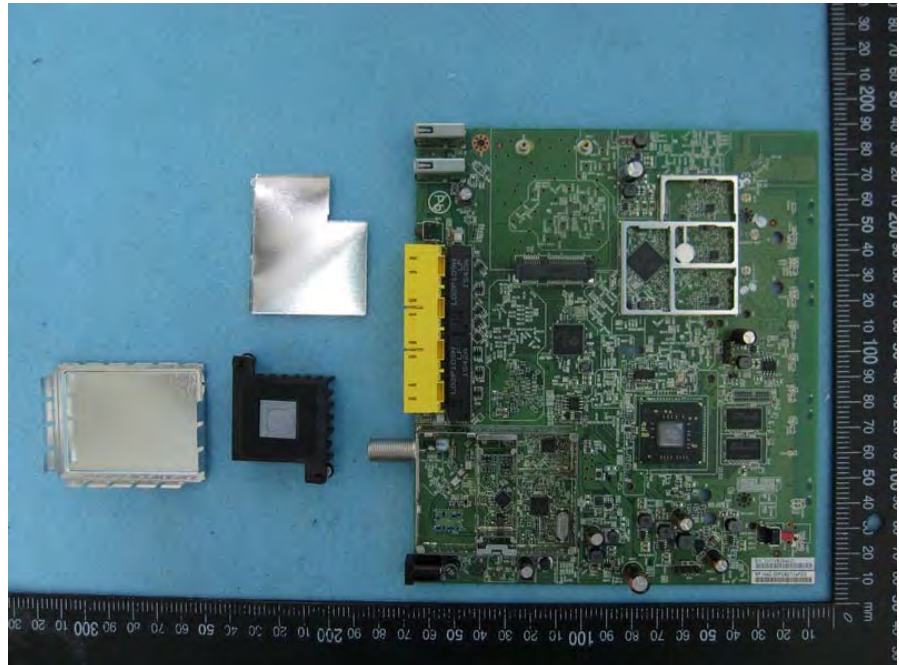




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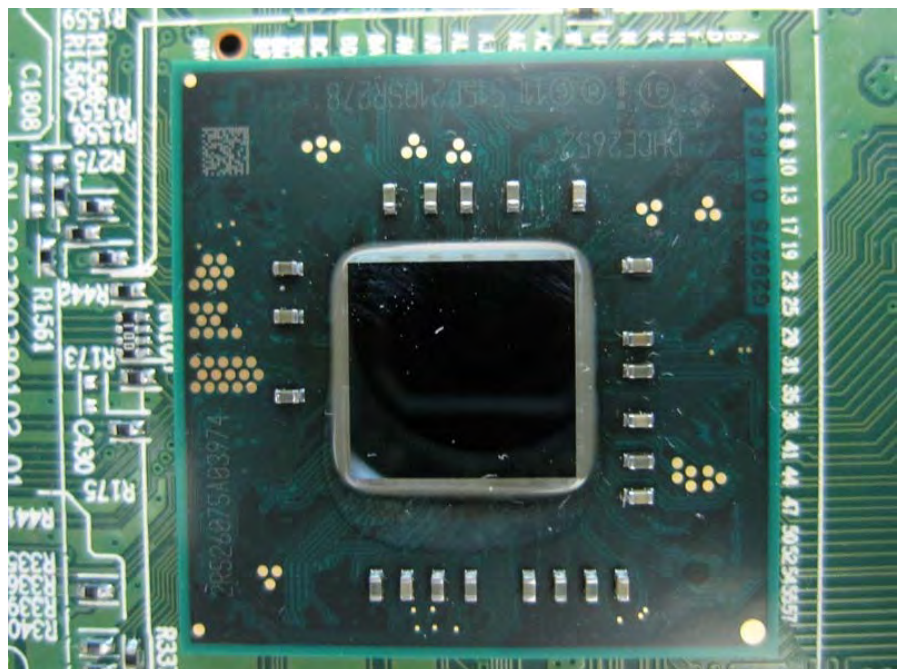


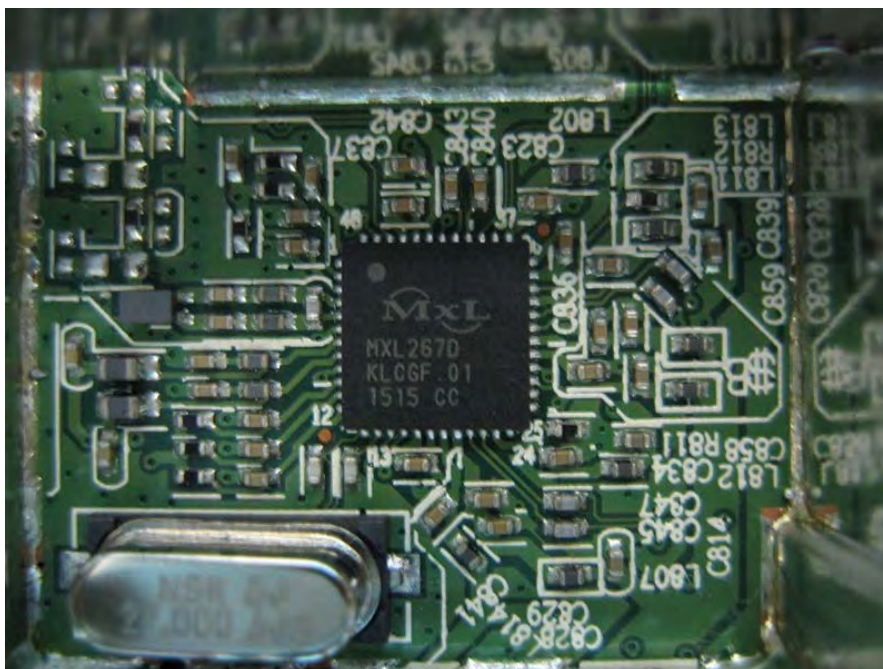
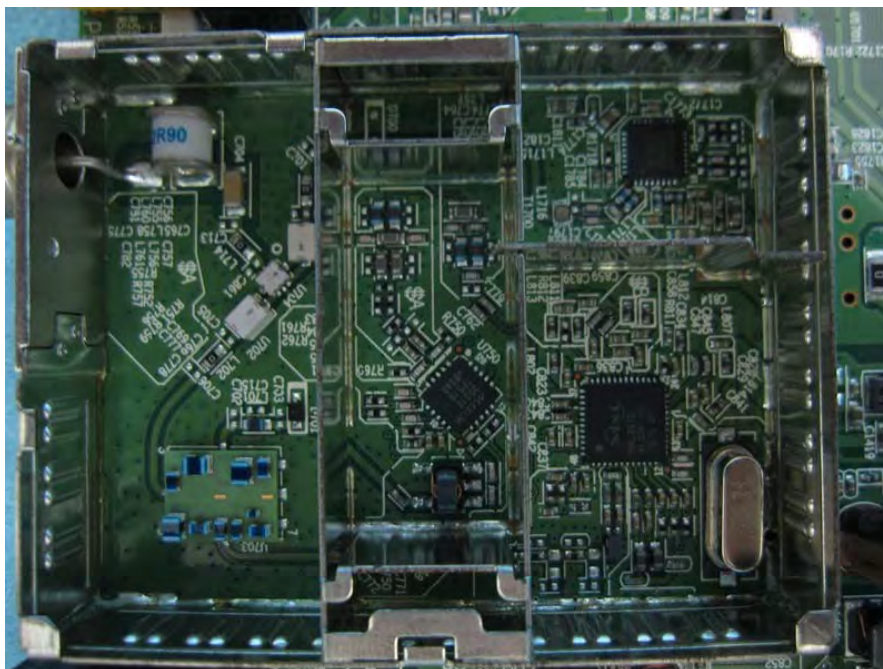


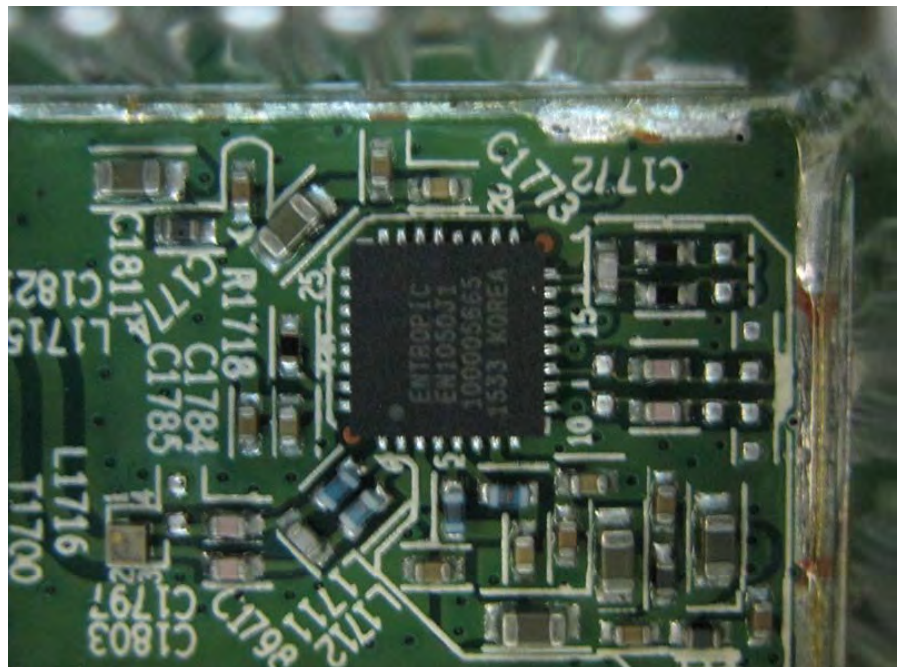
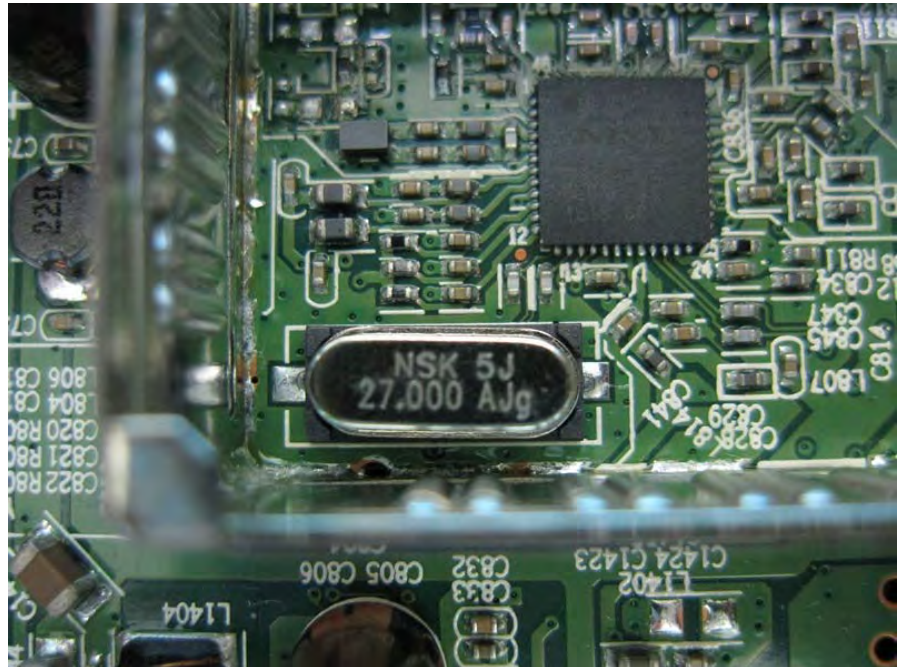


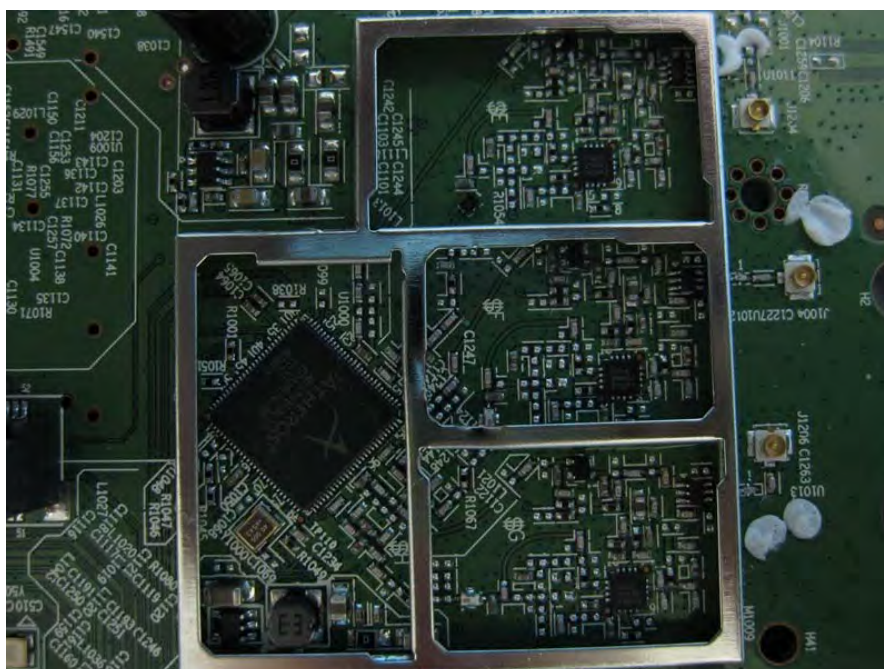
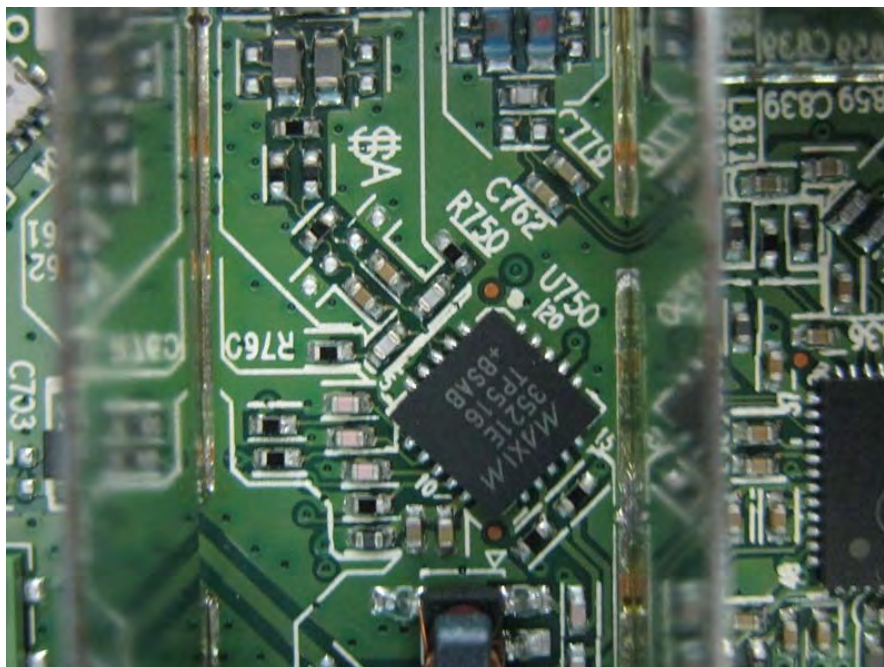
This image shows the internal components of a mobile phone, specifically the main printed circuit board (PCB). The board is green and populated with numerous electronic components. Key features include:

- Connectors:** A yellow USB connector is visible on the left side. A silver antenna connector is located at the bottom left.
- Microprocessors:** A large, square integrated circuit (IC) is mounted in the center, likely the main CPU. To its right, there are two smaller, rectangular ICs, possibly for memory or baseband processing.
- Other Components:** The board is covered with various smaller components, including capacitors, resistors, and smaller ICs. A black rectangular component, possibly a battery or a large capacitor, is visible near the top.
- Scale:** A ruler is placed below the board, indicating its size. The board is approximately 100 mm wide and 150 mm high.



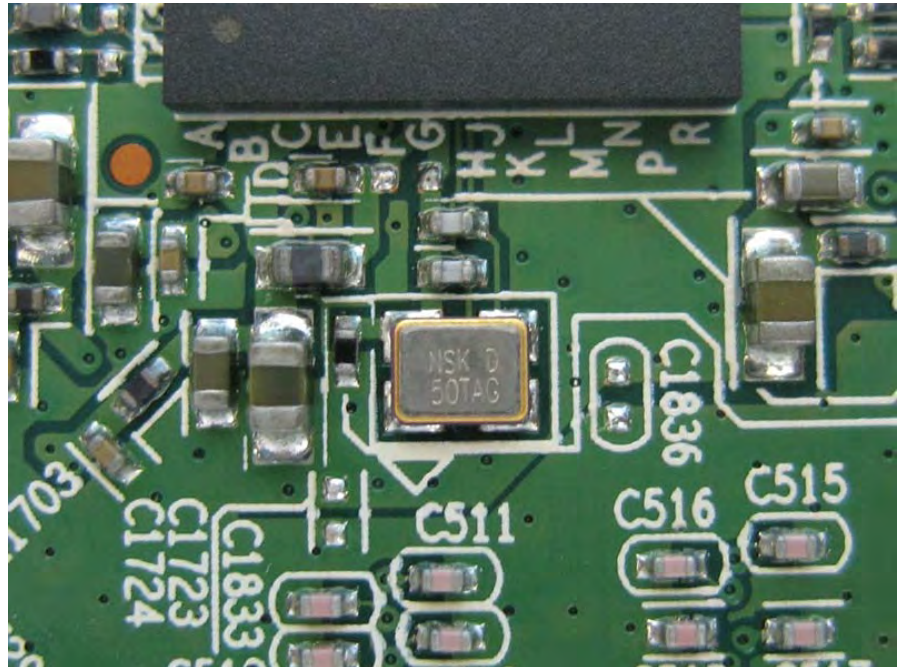












Second source of Power
Amplifier

